Vishay Siliconix



www.vishay.com

N-Channel 30 V (D-S) MOSFET

SOT-23 (TO-236)

Marking code: E8

PRODUCT SUMMARY						
V _{DS} (V)	30					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.028					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.033					
Q _g typ. (nC)	4.2					
I _D (A) ^{a, e}	6					
Configuration	Single					

FEATURES

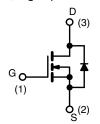
- TrenchFET® power MOSFET
- · Low on-resistance
- 100 % R_q tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



HALOGEN FREE

APPLICATIONS

DC/DC converters, high speed switching



N-Channel MOSFET

ORDERING INFORMATION				
Package	SOT-23			
Lead (Pb)-free and halogen-free	Si2338DS-T1-GE3			

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	30	V
Gate-source voltage		V _{GS}	± 20	v
	T _C = 25 °C		6 ^e	
Continuous drain surrent /T 150 °C)	T _C = 70 °C	1 ,	6 ^e	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	5.5 ^{b, c}	
	T _A = 70 °C		4.4 b, c	Α
Pulsed drain current (t = 300 μs)		I _{DM}	25	
Continuous source-drain diode current	T _C = 25 °C		2.1	
	T _A = 25 °C	I _S	1.1 ^{b, c}	
Maximum power dissipation	T _C = 25 °C		2.5	
	T _C = 70 °C		1.6	w
	T _A = 25 °C	P _D	1.3 ^{b, c}	
	T _A = 70 °C		0.8 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	
Soldering recommendations (peak temperature)			260	°C

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 5 s	R _{thJA}	75	100	°C/W		
Maximum junction-to-foot (drain)	Steady state	Rt _{hJF}	40	50	C/VV		

Notes

- a. Based on T_C = 25 $^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 166 °C/W
- e. Package limited

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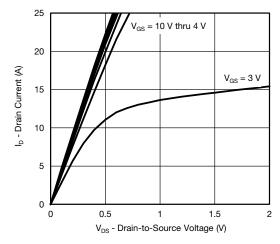
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-source breakdown voltage	V_{DS}	V _{GS} = 0 V, I _D = 250 μA	30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	30	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.8	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.2	-	2.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zono della collega della consella	1 .	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μА	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 70 °C	-	-	10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 5 \text{ V}, V_{GS} = 10 \text{ V}$	20	-	-	Α	
5	_ ` ′	$V_{GS} = 10 \text{ V}, I_D = 5.5 \text{ A}$	-	0.023	0.028	Ω	
Drain-source on-state resistance a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$	-	0.027	0.033		
Forward transconductance a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 5.5 \text{ A}$	-	24	-	S	
Dynamic ^b			1	1	•	•	
Input capacitance	C _{iss}		-	424	-		
Output capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	100	-	pF	
Reverse transfer capacitance	C _{rss}		-	42	-		
Total gate charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5.5 \text{ A}$	-	8.2	13		
			-	4.2	7		
Gate-source charge	Q _{as}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5.5 \text{ A}$	-	1.4	-	nC	
Gate-drain charge	Q _{qd}		-	1.4	-		
Gate resistance	R _g	f = 1 MHz	2.5	12.6	25.2	Ω	
Turn-on delay time	t _{d(on)}		-	6	12		
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_1 = 3.4 \Omega$	-	20	30		
Turn-off delay time	t _{d(off)}	$I_D \cong 4.4 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	14	21	1	
Fall time	t _f		-	10	20		
Turn-on delay time	t _{d(on)}		-	3	6	ns	
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_L = 3.4 \Omega$	-	11	20		
Turn-off delay time	t _{d(off)}	$I_D \cong 4.4 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	20	30		
Fall time	t _f		-	7	14		
Drain-Source Body Diode Characteristi	cs		1	1	•	•	
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	2.1		
Pulse diode forward current	I _{SM}		-	-	25	A	
Body diode voltage	V _{SD}	I _S = 4.4 A, V _{GS} = 0 V	-	0.82	1.2	V	
Body diode reverse recovery time	t _{rr}		-	13	20	ns	
Body diode reverse recovery charge	Q _{rr}	$I_F = 4.4 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	_	6	12	nC	
Reverse recovery fall time	t _a	T _J = 25 °C	_	8	-		
Reverse recovery rise Time	t _b		_	5	_	ns	

Notes

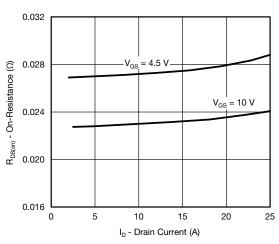
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

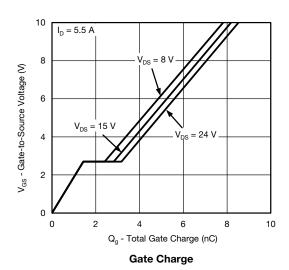


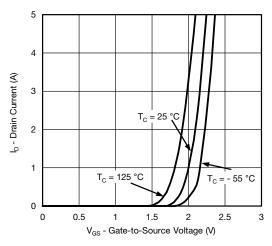


Output Characteristics

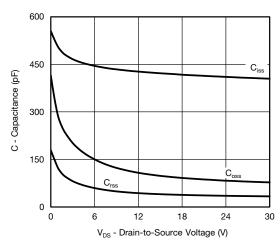


On-Resistance vs. Drain Current and Gate Voltage

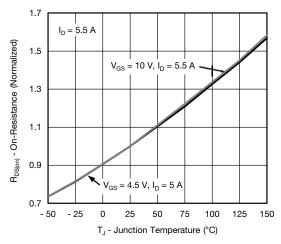




Transfer Characteristics

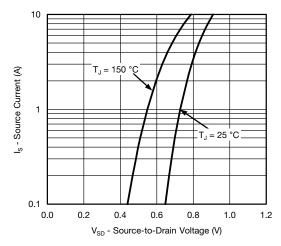


Capacitance

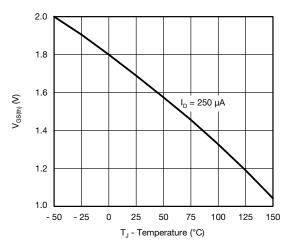


On-Resistance vs. Junction Temperature

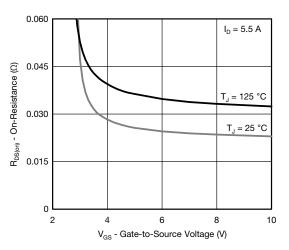




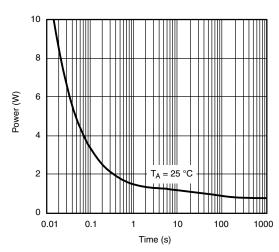
Source-Drain Diode Forward Voltage



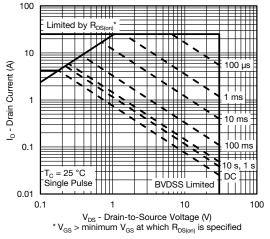
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

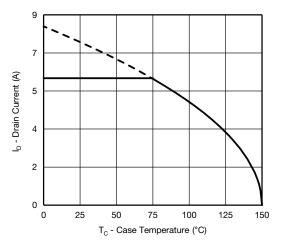


Single Pulse Power (Junction-to-Ambient)

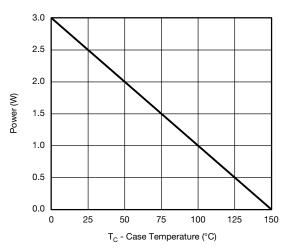


Safe Operating Area, Junction-to-Ambient

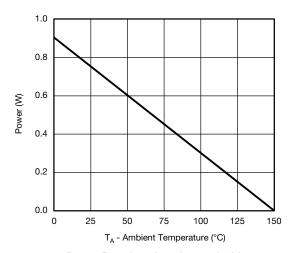




Current Derating a





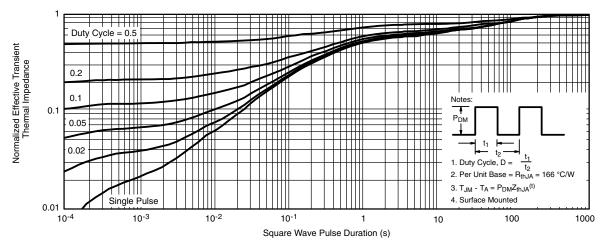


Power Derating, Junction-to-Ambient

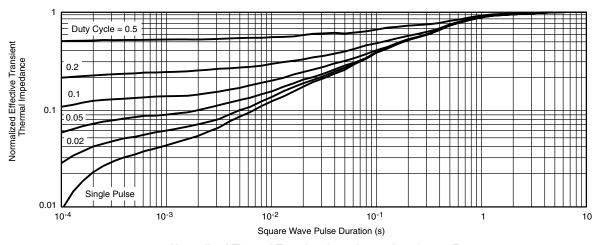
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

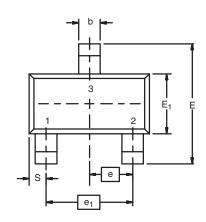


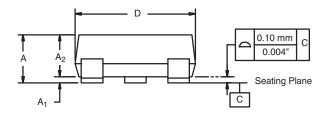
Normalized Thermal Transient Impedance, Junction-to-Foot

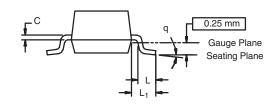
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SOT-23 (TO-236): 3-LEAD







Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
Е	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
FCN: S-03946-Rev K 09-	lul-01				

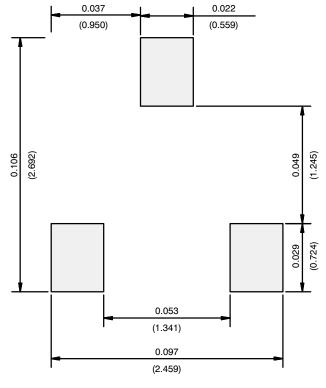
ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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